

## POWER DIODE MODULE

### Features

- All the terminals and the mounting plate are electrically isolated. These modules can be installed in the same cooling fin as other modules, thus saving installation space – a cost-effective feature.
- The diode chips are coated with a glass of zinc oxide, making them highly resistant to temperature and humidity variation.
- 6 diode chips are connected to the 3-phase bridge rectifying circuit inside the module-a cost-effective feature.

### Applications

- Inverters for AC motors
- Power supply units for DC motors
- DC power supply units for battery chargers
- General purpose DC power supply units

## Maximum Ratings and Characteristics

### Absolute Maximum Ratings

Items	Symbols	Conditions	6R130G		Units
			-120	-160	
Repetitive peak reverse voltage	$V_{RRM}$		1200	1600	V
Non-repetitive peak reverse voltage	$V_{RSM}$		1320	1760	V
Average output current	$I_O$	50/60 Hz Sinewave, $T_C = 88^\circ\text{C}$	30		A
Surge current	$I_{FSM}$	Rated load conditions	320		A
$I_t^2$	$I_t^2$	Rated load conditions	400		$\text{A}^2\text{s}$
Junction temperature	$T_j$		-40~+150		$^\circ\text{C}$
Storage temperature	$T_{stg}$		-40~+125		$^\circ\text{C}$
Tightening torque		Mounting screw: M5	25±5		kg·cm
Vibration resistance			5		G
Dielectric strength		Between terminals and base	2500 VAC 1 min		
Net. Weight			100		g

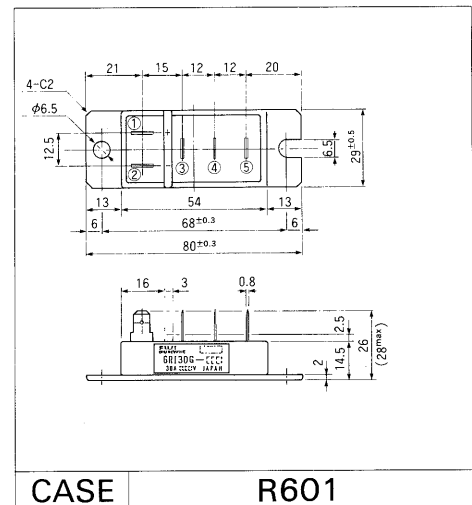
### Electrical Characteristics

Items	Symbols	Conditions	Min	Typ	Max	Units
Forward voltage	$V_{FM}$	$T_j = 25^\circ\text{C}$ , $I_{FM} = 30\text{ A}$			1.30	V
Reverse current	$I_{RRM}$	$T_j = 150^\circ\text{C}$ , $V_R = V_{RRM}$			30	mA

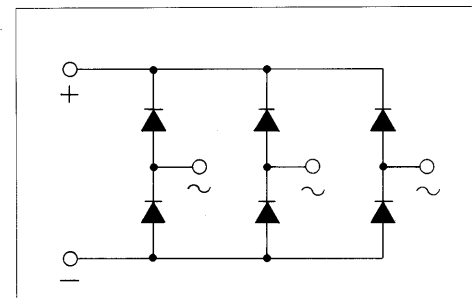
### Thermal Characteristics

Items	Symbols	Conditions	Min	Typ	Max	Units
Thermal resistance (Junction to case)	$R_{th(j-c)}$	50/60 Hz Sinewave, Thermal resistance for total loss			0.80	$^\circ\text{C}/\text{W}$
Thermal resistance	$R_{th(c-f)}$	With thermal compound			0.10	$^\circ\text{C}/\text{W}$

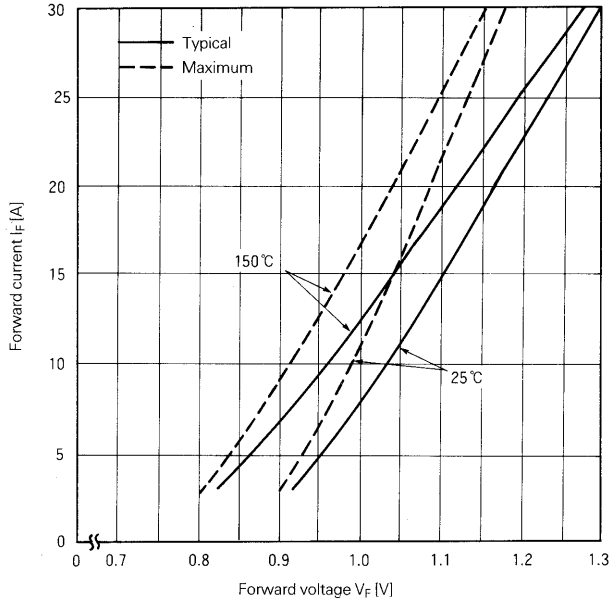
## Outline Drawings



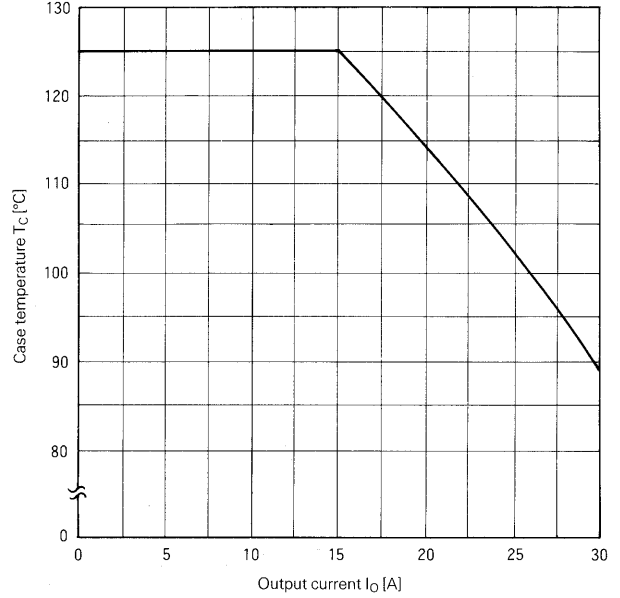
## Inner Circuit Schematic



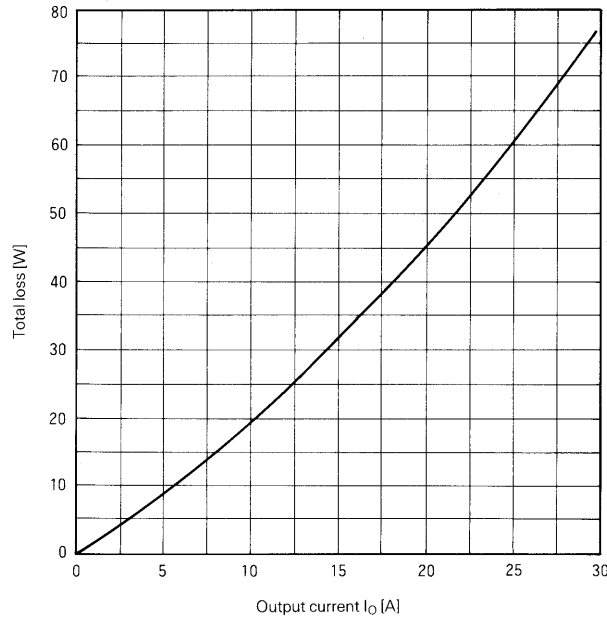
■ Characteristic curves



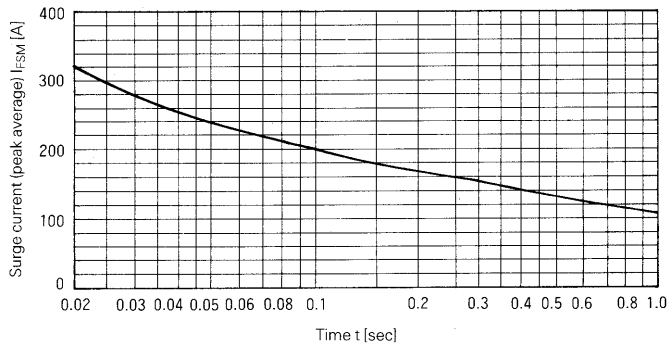
Forward Characteristics



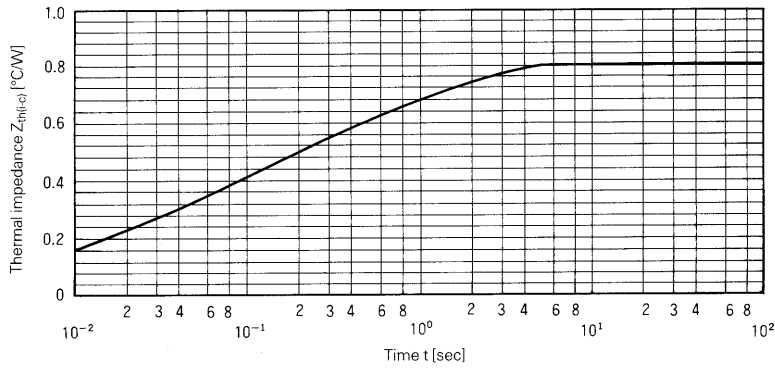
Case Temperature-Output Current



Output Current-Total Loss



Surge Current



Transient Thermal Impedance

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